ASSP DUAL REVERSIBLE MOTOR DRIVER MB3863

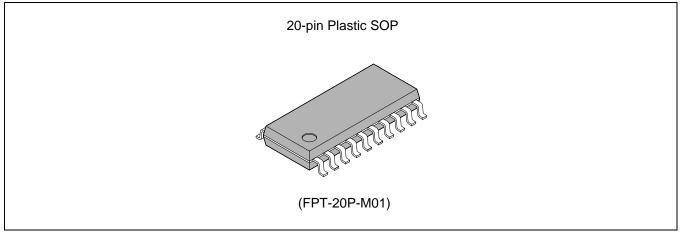
DESCRIPTION

The MB3863 is an IC motor driver with two independent reverse control functions. It drives motor drives of frontloading VTRs and auto-reverse cassette decks and stepping motors by reversible control at TTL and CMOS levels. A heat protection circuit is incorporated to prevent damage by overheating.

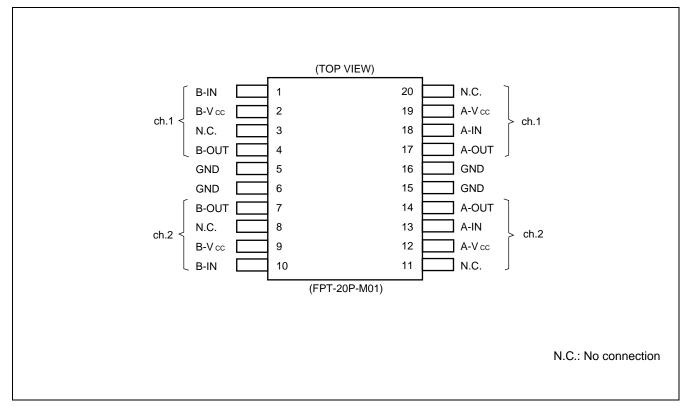
FEATURES

- Wide voltage range: Vcc = +4 to +36 V
- Motor drive current: 500 mA (1.2 A for surge current)
- Two internal independent drivers
- Internal heat protection circuit
- Control at TTL and CMOS level
- Stand-by mode
- · Brake function to stop motors
- Internal surge absorption diode
- Stepping motor application
- Symmetrical pin layout

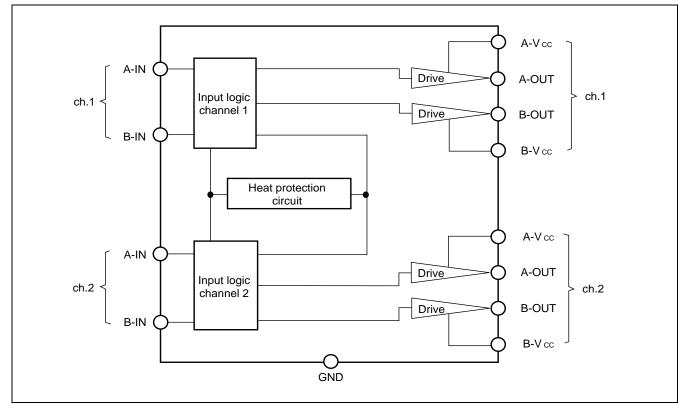
PACKAGE



■ PIN ASSIGNMENT



BLOCK DIAGRAM



ABSOLUTE MAXIMUM RATINGS

Parameter	Symbol	Rat	Unit	
Farameter	Min.			
Supply Voltage	Vcc		+38	V
Output Current	lo		550	mA
Maximum Output Current (within 5 ms)	IOmax	—	1.2	A
Allowable Loss	PD	—	1.6 (SOP-20)	W
Operating Temperature	Тор	-20	+75	°C
Storage Temperature	Tstg	-55	+150	°C

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

RECOMMENDED OPERATING CONDITIONS

Parameter		Symbol Rati Min.		ings	Unit	
				Max.		
Supply Voltage		Vcc	+4	+36	V	
Output Current		lo	0	500	mA	
Input Voltage	High level	Viн	2.4	Vcc +0.3	V	
input voltage	Low level	VIL	0	0.4	V	

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

■ ELECTRICAL CHARACTERISTICS

(V	$cc = 24 \text{ V}, \text{ Vin} = 2.4 \text{ V}, \text{ Ta} = +25 \circ \text{C}$	C)

Parameter		Symbol	Conditions		Unit		
		Symbol	Conditions	Min.	Тур.	Max.	Unit
Stand-by Supply V	oltage	Icco	Vcc = +24 V, $VIA = VIB = 0 V$		_	100	μΑ
		Icc1	lo = 0 mA	—	24	38	mA
Supply Voltage		Icc2	lcc2 lo = 500 mA —		24		mA
		Іссз	Io = 0 mA, VIA = VIB = +2.4 V		37	—	mA
	High level	Vон	lo = 500 mA	22.65	23	_	V
Output Voltage	Low level	Vol	lo = 500 mA		0.35	0.65	V
Saturated Output Voltage		VSAT	lo = 500 mA	_	1.35	2.00	V
Input Current		Ін	VIN = +2.4 V		250	400	μΑ
Surge Absorption Diode Voltage in Forward Direction		VF	lo = 1.2 A	_	2.0	_	V

OPERATIONS

1. Forward and Reverse

Switching control mode A or B pairs Q2 and Q3, or Q1 and Q4, respectively, while reversing the supply current to the motor for each switching. When Q2 and Q3 are in use, B-OUT and A-OUT are High level and Low level, respectively. In this case, current flows B-OUT \rightarrow motor \rightarrow A-OUT, causing forward operation as described in the table below.

When Q1 and Q4 are in use, current flows in the reverse direction to the above flow, causing reverse motor operation.

2. Brake

Control mode C operates Q2 and Q4 while stopping Q1 and Q3.

Since A-OUT and B-OUT are held at Low level, both poles of the motor are short-circuited and the motor is stopped.

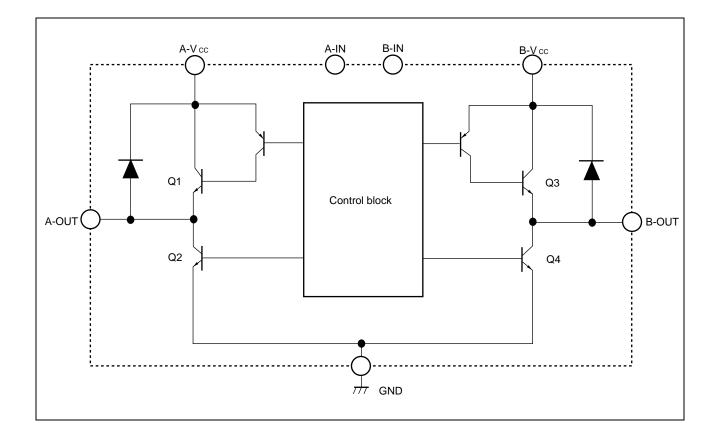
3. Stand-by

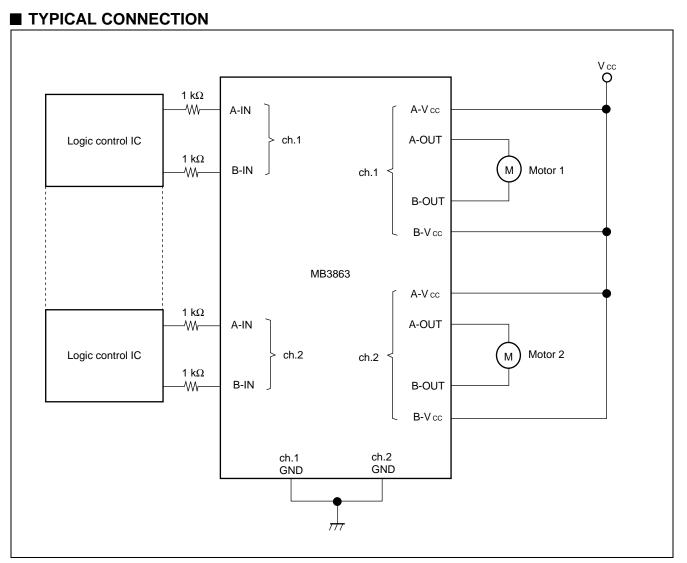
Control mode D turns Q1 to Q4 OFF and the motor has no current flow. In this mode, the power supply current is less than 100 $\mu A.$

Mode	Input	mode*	Operatio	on state of	f output tr	ansistor	State of output pin		Output operation mode	
woue	A=IN	B=IN	Q1	Q2	Q3	Q4	A-OUT	B-OUT		
А	1	0	OFF	ON	ON	OFF	L	Н	Forward (Reverse)	
В	0	1	ON	OFF	OFF	ON	Н	L	Reverse (Forward)	
С	1	1	OFF	ON	OFF	ON	L	L	Brake	
D	0	0	OFF	OFF	OFF	OFF	—	_	Open (High impedance)	

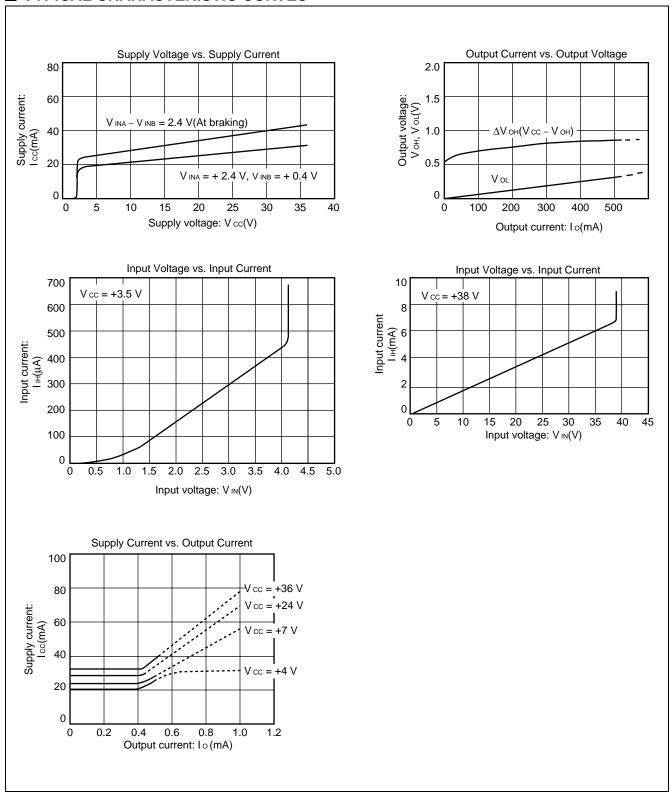
* : Input mode:1: +2.4 V Min.

0: +0.4 V Max.





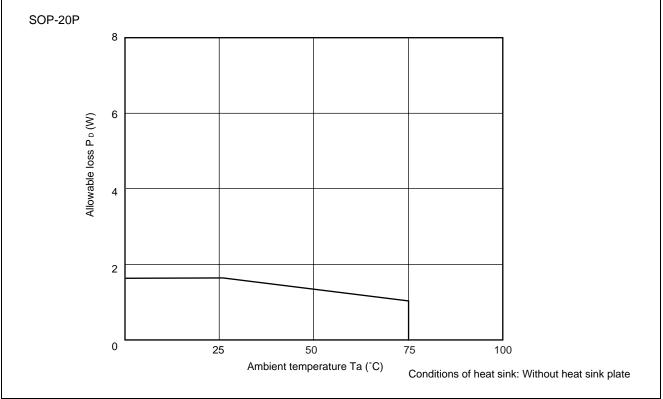
Note : If input voltage is applied when power is not supplied, over-current flows into the device via the input pins. In this case, connect a resistor of at least 1 k Ω in series with the input pins to prevent passage of a large current.



■ TYPICAL CHARACTERISTIC CURVES

Note : The above characteristic curves are at $Ta = +25^{\circ}C$

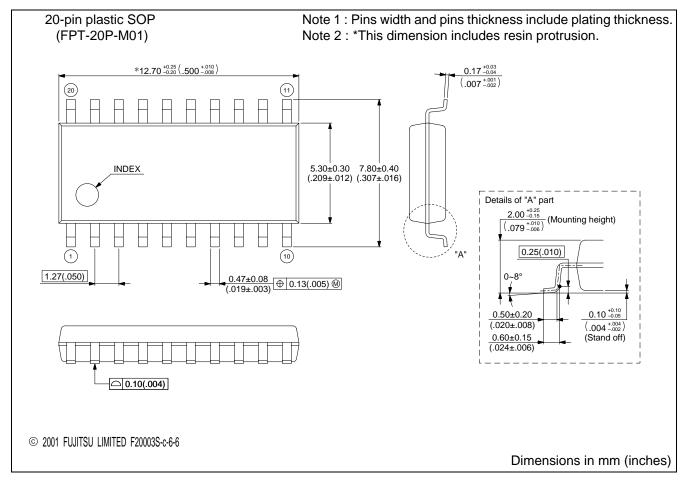
POWER DERATING CHARACTERISTICS



■ ORDERING INFORMATION

Part number	Package	Remarks
MB3863PF	20-pin plastic SOP (FPT-20P-M01)	

PACKAGE DIMENSION



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